

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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The Original Sil-Pad Material

Features and Benefits

- Thermal impedance:
 1.13°C-in²/W (@50 psi)
- · O riginal Sil-Pad material
- Excellent mechanical and physical characteristics
- · Flame retardant



Sil-Pad 400 is a composite of silicone rubber and fiberglass. The material is flame retardant and is specially formulated for use as a thermally conductive insulator. The primary use for Sil-Pad 400 is to electrically isolate power sources from heat sinks.

Sil-Pad 400 has excellent mechanical and physical characteristics. Surfaces are pliable and allow complete surface contact with excellent heat dissipation. Sil-Pad 400 actually improves its thermal resistance with age. The reinforcing fiberglass provides excellent cut-through resistance. In addition, Sil-Pad 400 is non-toxic and resists damage from cleaning agents.

Gr Fiber 0.007, 8: 30	rglass 0.009 5 0	Gr Fiber 0.178, 8	5	ASTM ASTM	D374	
Fiber 0.007, 83	rglass 0.009 5 0	Fiber 0.178, 8	glass 0.229	ASTM ASTM	D374	
0.007, 83 36 5-	0.009 5 0	0.178, 8	0.229 5	ASTM		
8: 30 54	5 0 4	8	5	ASTM		
30 54	0				D 2240	
30	4		5	4.077.7	ASTM D2240	
30	-	5		ASTM D1458		
	00	54		ASTM D412		
70 .	3000		20		ASTM D412	
-76 to 356		-60 to 180		_		
3500, 4500		3500, 4500		ASTM D149		
5.5		5.5		ASTM D150		
10 ¹¹		10 ¹¹		ASTM D257		
V-O		V-O		U.L. 94		
0.9		0.9		ASTM D5470		
E						
Pressure (psi)		25	50	100	200	
TO -220 Thermal Performance (°C/W) 0.007"		5.93	5.14	4.38	3.61	
TO -220 Thermal Performance (°C/W) 0.009"		7.62	6.61	5.63	4.64	
Thermal Impedance (°C-in²/W) 0.007"(1)		1.42	1.13	0.82	0.54	
Thermal Impedance (°C-in²/W) 0.009"(1)		1.83	1.45	1.05	0.69	
0	10 V- 0. E (psi) 0.007" 0.009"	10" V-O 0.9 (psi) 10 0.007" 6.62 0.009" 8.51 7"(1) 1.82	10" 10 V-O V- 0.9 0.5 (psi) 10 25 0.007" 6.62 5.93 0.009" 8.51 7.62 7"(1) 1.82 1.42	10" 10" 10" V-O V-O	10" 10" ASTM V-O V-O U.L 0.9 0.9 ASTM E (psi) 10 25 50 100 1.007" 6.62 5.93 5.14 4.38 1.009" 8.51 7.62 6.61 5.63 7"(1) 1.82 1.42 1.13 0.82	

¹⁾ The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness flatness and pressure applied.

Typical Applications Include:

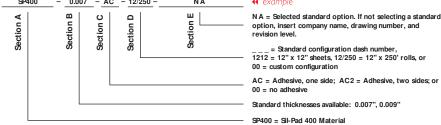
- Power supplies
- · Automotive electronics
- · Power semiconductors
- Motor controls

Configurations Available:

· Sheet form, die-cut parts and roll form; with or without pressure sensitive adhesive

Building a Part Number

Standard Options



Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad® U.S. Patents 4,574,879; 4,602,125; 4,602,678; 4,685,987; 4,842,911 and others